WIRELESS, RF, AND CABLE

APPLICATION NOTE 1002

MAX2291 for W-CDMA Application

The MAX2291 is a chip-scale-packaged linear RF power amplifier (PA) which was designed for use in N-CDMA handsets at the PCS band. It performs well in the 1920MHz to 1980MHz W-CDMA band by changing the input and output match circuits. Bench measurements for the high-power path show -38dBc ACP1, -64dB ACP2, and 37% PAE at +28dBm at 1950MHz. Bench measurements for the low-power path show -38dBc ACP1, -53dBc ACP2, and 12% PAE at +16dBm at 1950MHz.

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High-Power-Mode Measurements (Vcc at 3.5VDC):

- Pout = 28dBm
- Frequency = 1.95GHz
- ACP1 = -38dBc (measured at 5MHz offset in 3.84MHz bandwidth)
- ACP2 = -64dBc (measured at 10MHz offset in 3.84MHz bandwidth)
- Power-added efficiency = 37%
- Idle Icc = 97mA

Gain was measured at approximately 27dB with a -2dB slope over the band.

Low-Power-Mode Measurements (Vcc at 3.5VDC):

- Pout = 16dBm
- Frequency = 1.95GHz
- ACP1 = -38dBc (measured at 5MHz offset in 3.84MHz bandwidth)
- ACP2 = -53dBc (measured at 10MHz offset in 3.84MHz bandwidth)
- Power-added efficiency = 12%
- Idle Icc = 30mA

Gain was measured at approximately 13dB with a -2dB slope over the band.

W-CDMA Application Test Setup

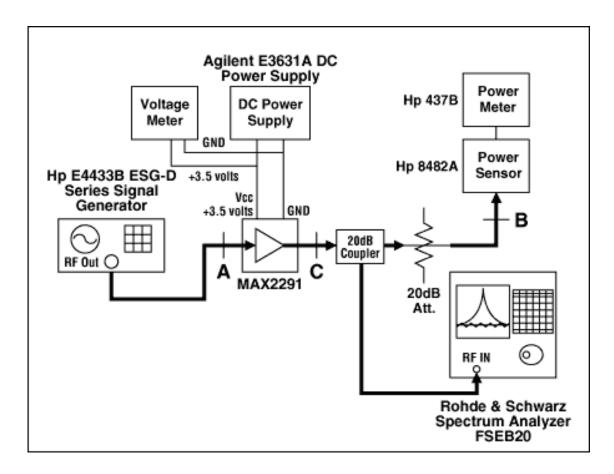
Equipment Used (See the Diagram Below):

- E4433B signal generator
- Rohde & Schwartz FSEA or FSEB
- Power supply, RF coupler, 20dB pad, RF power meter

On the E4433B, select 3GPP modulation, up link, DPCCH + 1 DPDCH.

ACPR Measurements:

- Channel BW = 3.84MHz
- First offset = +/-3.5MHz in 30kHz
- Second offset = +/-5MHz in 3.84MHz
- Third offset = +/-10MHz in 3.84MHz



MAX2291 application as W-CDMA power amplifier

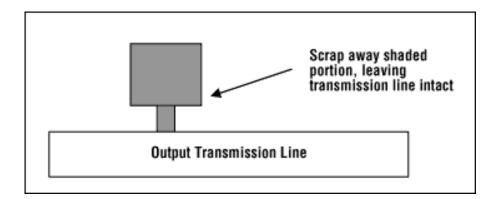
Table 1. Bill of Materials

DESIGNATION	QTY	DESCRIPTION
C90	1	ATC 3.9pF ±0.1pF ATC600S3R9BW (see Special Assembly Instructions, 4)
C91	1	ATC 3.3pF ±0.1pF ATC600S3R3BW (see Special Assembly Instructions, 4)
C92	1	Murata 0.5pF ±0.1pF GRM36COG0R5B50 (see Special Assembly Instructions, 1)
C17, C46, C47, C50, L8, L12, D1, R2, IN4SMA	9	No install
C45, C54, C57, C64	4	Murata 0.01uF GRM36X7R103K16
C48	1	Murata 470pF GRM36X7R471K50
C49	1	Murata 5.6pF ±0.1pF GRM36COG5R6B50
C52	1	Murata 1.3pF ±0.1pF GRM36COG1R3B50
C56	1	Murata 9.1pF ±0.1pF GRM36COG9R1B50

case size
ns, 2)
older to 2-pin

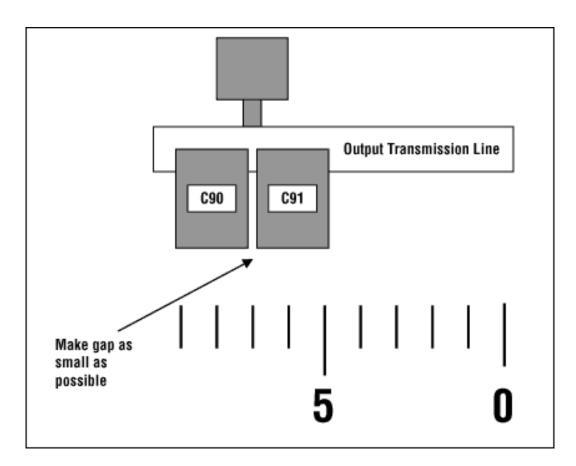
Special Assembly Instructions

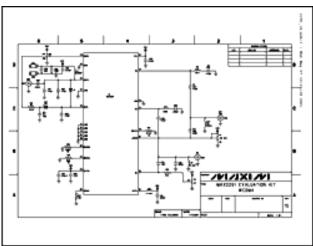
- 1. Mount between the outside edge of C52 (facing SMA) and the ground pad of L9.
- 2. Before mounting L11, the lower pad should be removed, as illustrated below:



The top lead of the inductor should be clipped to fit the upper pad. The bottom lead should be bent so that it reaches the output transmission line, where it will be soldered down.

- 3. Cut a small piece of bus wire, and solder it between the pads designated L15.
- 4. C90 should be at the left edge of tick mark #10, and C91 should be placed immediately adjacent, as shown below:





For larger image (PDF, 324k)

MAX2291 Evaluation Kit, W-CDMA

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